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For Immediate Release

Seika Machinery to Spotlight Sayaka PCB Routers and Sawa Ultrasonic Cleaners at SMTA LA/OC Expo & Tech Forum 2026

TORRANCE, CA — November 2026 — Seika Machinery, Inc., a leading provider of advanced machinery, materials and engineering services, is pleased to announce its participation in the SMTA LA/OC Expo & Tech Forum 2026, taking place Tuesday, November 17, 2026, at the Highway 39 Event Center in Anaheim, California. Product managers will highlight the Sayaka PCB router line and Sawa ultrasonic cleaning systems, offering attendees an opportunity to explore solutions designed to improve manufacturing efficiency, process consistency and product quality.

The Sayaka PCB router line provides manufacturers with precise, reliable depaneling solutions designed to separate individual circuit boards from assembled panels while minimizing mechanical stress on sensitive components. Engineered for accuracy, ease of operation and efficient production, Sayaka routers support a range of PCB assembly applications and help manufacturers maintain consistent quality throughout the depaneling process.

Seika also will feature Sawa ultrasonic cleaning systems, designed to support effective cleaning and maintenance of critical electronics manufacturing equipment and components. Utilizing ultrasonic cleaning technology, Sawa systems help remove solder paste, flux residues and other contaminants from applicable production tools and equipment, supporting consistent process performance, reduced maintenance requirements and improved operational efficiency.



“The SMTA LA/OC Expo provides an excellent opportunity to connect with manufacturers and discuss solutions to their production challenges,” said Michelle Ogihara, Executive Vice President of Seika Machinery, Inc. “With our Sayaka and Sawa product managers on hand, attendees can receive firsthand technical guidance on improving efficiency, quality and reliability in their manufacturing processes.”

The product managers representing both lines will be available throughout the show to provide technical consultations, discuss specific manufacturing challenges and help attendees identify solutions suited to their production requirements. The event provides an opportunity for manufacturers to learn more about Seika Machinery’s equipment offerings and explore solutions to improve productivity, reliability and overall manufacturing performance.

For more information, contact Michelle Ogihara at 310-540-7310; e-mail michelle@seikausa.com; or visit www.seikausa.com.

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About Seika Machinery, Inc.

Seika Machinery, Inc. (SMI) is a subsidiary of Seika Corporation, Japan and member of the Mitsubishi Global Group. SMI provides electronics manufacturers with advanced machinery, superior materials and engineering services.